

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shekar Mallikarjunaswamy	04/26/2011
RECEIVING PARTY DATA	
Name:	Alpha and Omega Semiconductor Incorporated
Street Address:	475 Oakmead Pkwy
City:	Sunnyvale
State/Country:	CALIFORNIA
Postal Code:	94085
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13351186
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ATTORNEY DOCKET NUMBER:	AOS-0606C
NAME OF SUBMITTER:	Bo-In Lin
Signature:	/Bo-In Lin/
Date:	08/21/2013
Total Attachments: 1 source=AOS0606DD Assignment#page1.tif	

OP \$40.00 13351186

**ASSIGNMENT**

INVENTOR                      Whereas, I, **Shekar Mallikarjunaswamy** of 258 Coffeeberry Drive  
AND CITY                      San Jose, CA 95123

have invented:

TITLE:                      **CIRCUIT CONFIGURATIONS TO REDUCE SNAPBACK OF A  
TRANSIENT VOLTAGE SUPPRESSOR**

DATE INVENTOR and executed a United States patent application therefor  
SIGNED THE  
DECLARATION              on April 26, 2011;

Whereas, **Alpha and Omega Semiconductor Incorporated**, a California Company, having its registered address at 475 Oakmead Parkway, Sunnyvale, CA 94085, USA, (hereinafter called **AOS**), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to **AOS**, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to **AOS** its successors and assigns; and I hereby agree that **AOS** may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND                      Signed and Sealed at Sunnyvale, California

DATE                              on April 26, 2011.



SIGNATURE OF INVENTOR